



### **N-CHANNEL ENHANCEMENT MODE MOSFET**

## **Product Summary**

BVsss	Rss(on) Typ	Is Max T <sub>A</sub> = +25°C
24V	$3.1 \text{m}\Omega$ @ V <sub>GS</sub> = $3.8 \text{V}$	26.5A

### **Description**

This new generation MOSFET is designed to minimize the on-state resistance (Rss(on)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- · Battery Management
- Load Switch
- Battery Protection

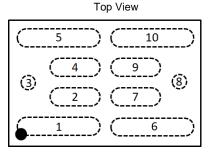
### **Features**

- CSP with Footprint 3.20mm x 2.10mm
- Height = 0.120mm (Typical) for Low Profile
- ESD Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>

### **Mechanical Data**

- Package: X4-DSN3221-10
- Terminal Connections: See Diagram Below
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiAu. Solderable per MIL-STD-202, Method 208 (a)
- Weight: 0.0016 grams (Approximate)

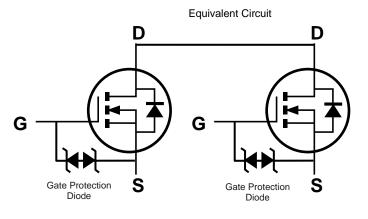




Source 1: 1, 2, 4, 5 Gate1: 3

Source 2: 6, 7, 9, 10

Gate 2: 8



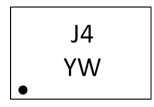
### Ordering Information (Note 4)

Part Number	Pookage	Packing			
Fait Nulliber	Package	Qty.	Carrier		
DMN22M5UCA10-7	X4-DSN3221-10	3000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



J4 = Product Type Marking Code YW = Date Code Marking Y or  $\overline{Y}$  = Year (ex: 1 = 2021) W or  $\overline{W}$  = Week (ex: a = Week 27; z Represents Week 52 and 53)

Date Code Key

Date Code Hoy												
Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2

	Week	1-26	27-52	53
ĺ	Code	A-Z	a-z	Z



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Source-Source Voltage			Vsss	24	V
Gate-Source Voltage	$V_{GSS}$	±12	V		
0 ( 0 0 1/1)	Steady	T <sub>A</sub> = +25°C		26.5	Α
Continuous Source Current (Note 5) V <sub>GS</sub> = 4.5V	State	T <sub>A</sub> = +70°C	Is	21.5	
	Steady	T <sub>A</sub> = +25°C		16.5	
Continuous Source Current (Note 5) V <sub>GS</sub> = 2.5V	State	T <sub>A</sub> = +70°C	Is	13.5	А
Pulsed Source Current (Note 6)	Іѕм	110	Α		

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P <sub>D</sub>	0.96	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 7)	Reja	130	°C/W
Power Dissipation (Note 5)	PD	3.14	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	$R_{\theta JA}$	39.8	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

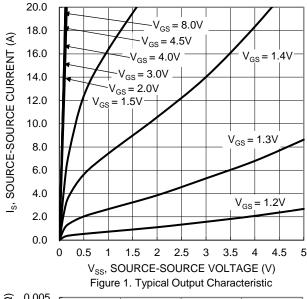
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	- Cyllison	1	. , , ,	mux	- Oille	rest containen	
Source-Source Breakdown Voltage	BVsss	24	_	_	V	Vgs = 0V, Is = 1mA	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	Isss	_	_	1	μΑ	Vss = 19.2V, Vgs = 0V	
Gate-Source Leakage	lgss	_	_	±10	μA	Vgs = ±8V, Vss = 0V	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.4	_	1.3	V	$V_{SS} = 10V, I_S = 1mA$	
		1.6	3.0	4.0		Vgs = 4.5V, Is = 5A	
Static Source-Source On-Resistance		1.7	3.1	4.1	mΩ	Vgs = 3.8V, Is = 5A	
Static Source-Source On-Resistance	R <sub>SS(ON)</sub>	2.0	3.4	4.7	mΩ	Vgs = 3.1V, Is = 5A	
		2.2	3.8	7.4		Vgs = 2.5V, Is = 5A	
Diode Forward Voltage	Vss	_	_	1.2	V	Vgs = 0V, Is = 3A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	3490	_		Vss = 12V, Vgs = 0V, f = 1.0kHz	
Output Capacitance	Coss	_	400	_	pF		
Reverse Transfer Capacitance	Crss	_	220	_		I = 1.0KHZ	
Gate Resistance	Rg	_	281	_	Ω	$V_{GS} = 0V$ , $V_{DS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	40.7	_			
Gate-Source Charge	Q <sub>gs</sub>	_	6.9	_	nC	$V_{DD} = 12V, V_{GS} = 4.5V,$	
Gate-Drain Charge	Qgd	_	10.5	_	nC	Is = 5A	
Gate Charge at VTH	Q <sub>g</sub> (TH)	_	3.5	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	326	_			
Turn-On Rise Time	t <sub>R</sub>	_	869	_		$V_{DD} = 12V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	2664	_	ns	I <sub>S</sub> = 5A	
Turn-Off Fall Time	tr	_	2580	_			

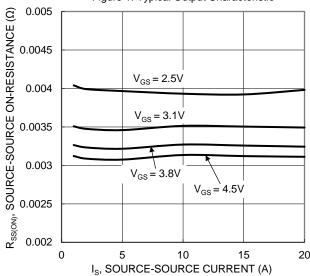
Notes:

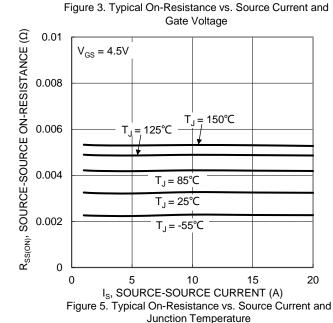
- Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
   Repetitive rating, pulse width limited by junction temperature.
   Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to production testing.

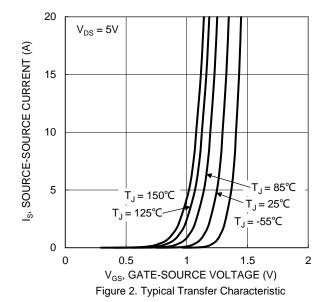
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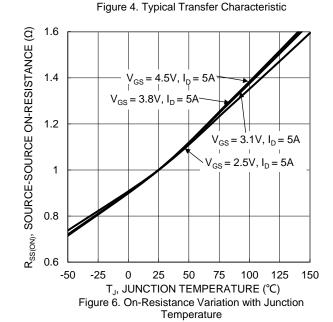














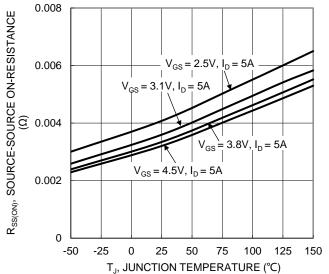
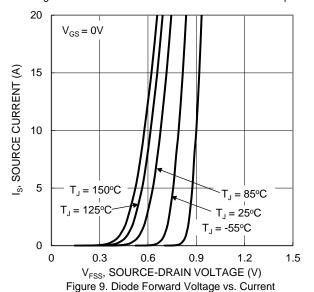
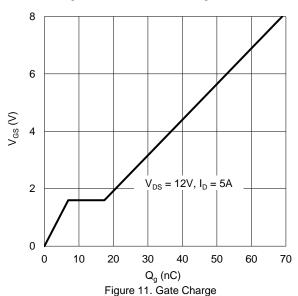


Figure 7. On-Resistance Variation with Junction Temperature





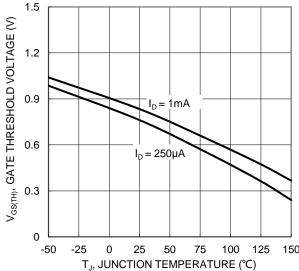
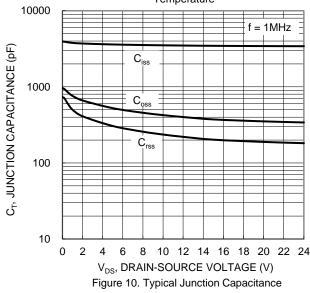


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 R<sub>DS(ON)</sub> Limited  $= 100 \mu s$ 100 = 1 msID, DRAIN CURRENT (A) 10  $_{v} = 10 ms$  $P_{W} = 100m$  $T_{J(Max)} = 150$ °C T<sub>A</sub> = 25°C Single Pulse DUT on 1\*MRP Board  $V_{GS} = 4.5V$ 0.01 0.01 100 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



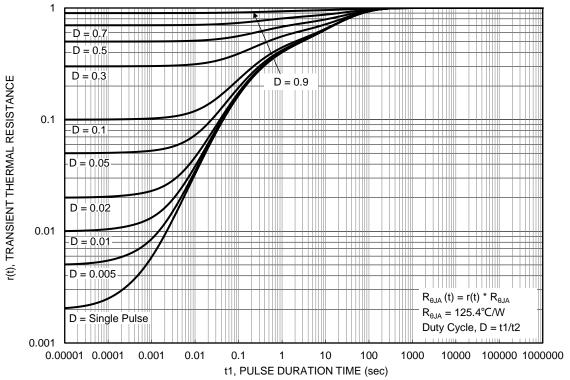


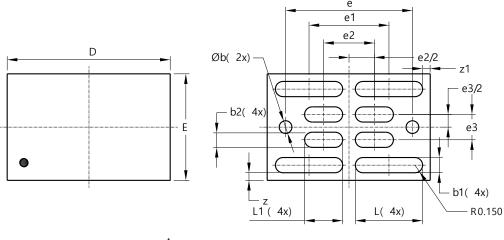
Figure 13. Transient Thermal Resistance



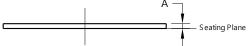
# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X4-DSN3221-10



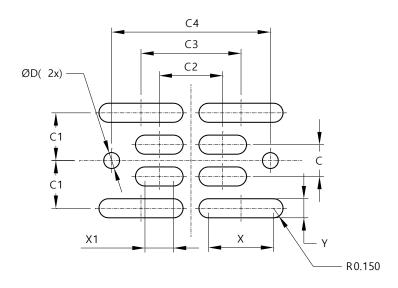
X4-DSN3221-10									
Dim	Min	Max	Тур						
Α		0.150	0.120						
b	0.220	0.280	0.250						
b1	0.270	0.330	0.300						
b2	0.270	0.330	0.300						
D	3.170	3.230	3.200						
Е	2.070	2.130	2.100						
e	(2	2.500 B	SC						
e1	1	.575 B	SC						
e2	1	.000 B	SC						
е3	C	).500 B	SC						
L	1.295	1.355	1.325						
L1	0.720	0.780	0.750						
Z	0.120	0.180	0.150						
z1	0.120	0.170	0.150						
All	Dimen	sions i	All Dimensions in mm						



# **Suggested Pad Layout**

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$ 

#### X4-DSN3221-10



Dimensions	Value
Dilliensions	(in mm)
С	0.500
C1	0.750
C2	1.000
C3	1.575
C4	2.500
D	0.250
Х	1.025
X1	0.450
Y	0.300



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